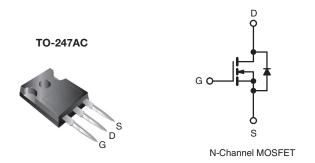


### Power MOSFET

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	200	200			
$R_{DS(on)}(\Omega)$	V <sub>GS</sub> = 10 V	0.085			
Q <sub>g</sub> (Max.) (nC)	140	140			
Q <sub>gs</sub> (nC)	28	28			
Q <sub>gd</sub> (nC)	74	74			
Configuration	Sing	Single			



### **FEATURES**

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- Isolated Central Mounting Hole
- Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC



### **DESCRIPTION**

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effictiveness.

The TO-220AB package is universially preferred for commercial-industrial applications where higher power levels preclude the use of TO-220AB devices. The TO-247AC is similar but superior to the earlier TO-218 package because of its isolated mounting hole. It also provides greater creepage distance between pins to meet the requirements of most safety specifications.

ORDERING INFORMATION	
Package	TO-247AC
Lead (Pb)-free	IRFP250PbF
Lead (PD)-life	SiHFP250-E3
SnPb	IRFP250
SIIFU	SiHFP250

PARAMETER			SYMBOL	LIMIT	UNIT
Drain-Source Voltage			V <sub>DS</sub>	200	V
Gate-Source Voltage			$V_{GS}$	± 20	•
Continuous Drain Current	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 25 °C	l-	30	
Continuous Drain Current	VGS at 10 V	$T_C = 100 ^{\circ}C$	I <sub>D</sub>	19	Α
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	120	
Linear Derating Factor				1.5	W/°C
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	410	mJ
Repetitive Avalanche Currenta			I <sub>AR</sub>	30	А
Repetitive Avalanche Energy <sup>a</sup>			E <sub>AR</sub>	19	mJ
Maximum Power Dissipation $T_C = 25 ^{\circ}\text{C}$			P <sub>D</sub>	190	W
Peak Diode Recovery dV/dt <sup>c</sup>			dV/dt	5.0	V/ns
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 150	°C
Soldering Recommendations (Peak Temperature) for 10 s				300 <sup>d</sup>	1
Mounting Torque	6.00 1	40 a a r a r i		10	lbf · in
Mounting Torque	6-32 or M3 screw		Ī	1.1	N⋅m

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b.  $V_{DD}$  = 50 V, starting  $T_J$  = 25 °C, L = 683  $\mu$ H,  $R_g$  = 25  $\Omega$ ,  $I_{AS}$  = 30 A (see fig. 12). c.  $I_{SD}$  ≤ 30 A, dI/dt ≤ 190 A/ $\mu$ s,  $V_{DD}$  ≤  $V_{DS}$ ,  $T_J$  ≤ 150 °C.
- d. 1.6 mm from case.

<sup>\*</sup> Pb containing terminations are not RoHS compliant, exemptions may apply



THERMAL RESISTANCE RATINGS					
PARAMETER SYMBOL TYP. MAX. UNIT					
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	40		
Case-to-Sink, Flat, Greased Surface	R <sub>thCS</sub>	0.24	-	°C/W	
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-	0.65		

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> = 250 μA	200	-	_	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I <sub>D</sub> = 1 mA	-	0.27	-	V/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 250 μA	2.0	-	4.0	V
Gate-Source Leakage	$I_{GSS}$	,	$V_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>		= 200 V, V <sub>GS</sub> = 0 V	-	-	25	μA
Zoro date voltage Brain Garront	טאי		/, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	250	μπ
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	$I_D = 18 A^b$	-	-	0.085	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub>	= 50 V, I <sub>D</sub> = 18 A	12	-	-	S
Dynamic							,
Input Capacitance	C <sub>iss</sub>		$V_{GS} = 0 V$	-	2800	-	
Output Capacitance	$C_{oss}$		$V_{DS} = 25 \text{ V},$	-	780	-	pF
Reverse Transfer Capacitance	$C_{rss}$	T = 1	.0 MHz, see fig. 5	-	250	-	
Total Gate Charge	$Q_g$			-	-	140	
Gate-Source Charge	$Q_{gs}$	V <sub>GS</sub> = 10 V	$V_{GS} = 10 \text{ V}$ $I_D = 30 \text{ A}, V_{DS} = 160 \text{ V},$ see fig. 6 and $13^b$		-	28	nC
Gate-Drain Charge	$Q_{gd}$				-	74	
Turn-On Delay Time	$t_{d(on)}$				16	-	- ns
Rise Time	t <sub>r</sub>	$V_{DD} = 100 \text{ V}, I_{D} = 30 \text{ A},$ $R_{g} = 6.2 \ \Omega, \ R_{D} = 3.2 \ \Omega, \ \text{see fig. } 10^{\text{b}}$		-	86	-	
Turn-Off Delay Time	t <sub>d(off)</sub>			-	70		
Fall Time	t <sub>f</sub>			-	62	-	
Internal Drain Inductance	L <sub>D</sub>	6 mm (0.25") 1	Between lead, 6 mm (0.25") from		5.0	-	nH
Internal Source Inductance	L <sub>S</sub>	package and center of die contact		-	13	-	11111
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	Is	MOSFET symbol showing the integral reverse p - n junction diode		-	-	30	
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>			-	-	120	Α
Body Diode Voltage	V <sub>SD</sub>	$T_J = 25 ^{\circ}\text{C},  I_S = 30  \text{A},  V_{GS} = 0  \text{V}^b$		-	-	2.0	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	T 05.00	00 4 11/11 400 11/	-	360	540	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	$T_J = 25  ^{\circ}\text{C}, I_F = 30  \text{A},  \text{dI/dt} = 100  \text{A/}\mu\text{s}$		-	4.6	6.9	μC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-on is dominated by			v L <sub>S</sub> and	L <sub>D</sub> )	

### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width  $\leq$  300  $\mu$ s; duty cycle  $\leq$  2 %.



### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

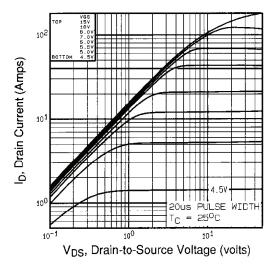


Fig. 1 - Typical Output Characteristics,  $T_C = 25$  °C

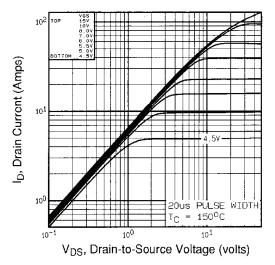


Fig. 2 -Typical Output Characteristics, T<sub>C</sub> = 150 °C

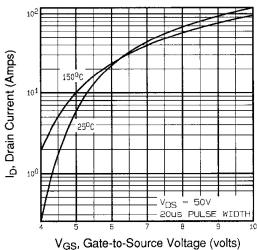


Fig. 3 - Typical Transfer Characteristics

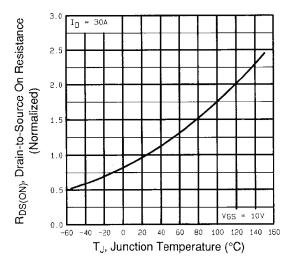


Fig. 4 - Normalized On-Resistance vs. Temperature



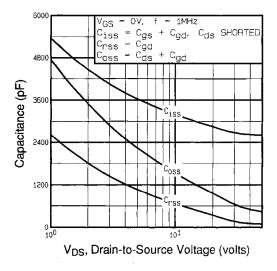


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

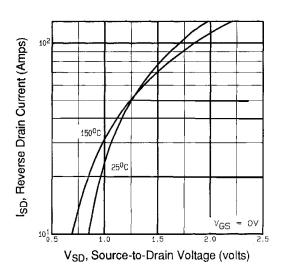


Fig. 7 - Typical Source-Drain Diode Forward Voltage

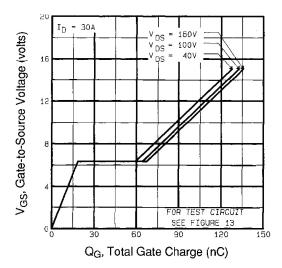


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

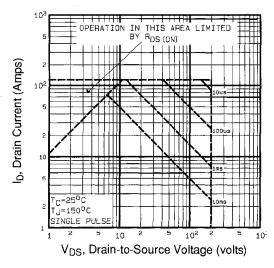


Fig. 8 - Maximum Safe Operating Area



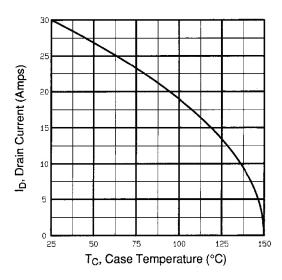


Fig. 9 - Maximum Drain Current vs. Case Temperature

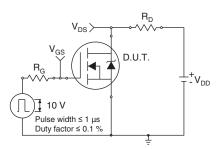


Fig. 10a - Switching Time Test Circuit

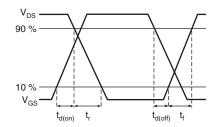


Fig. 10b - Switching Time Waveforms

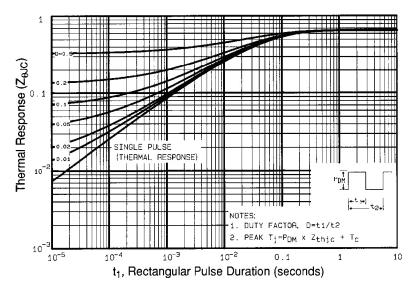


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

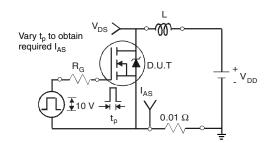


Fig. 12a - Unclamped Inductive Test Circuit

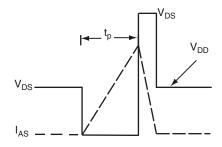


Fig. 12b - Unclamped Inductive Waveforms



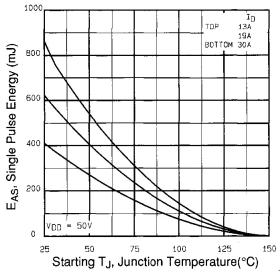


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

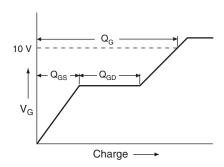


Fig. 13a - Basic Gate Charge Waveform

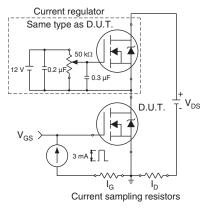
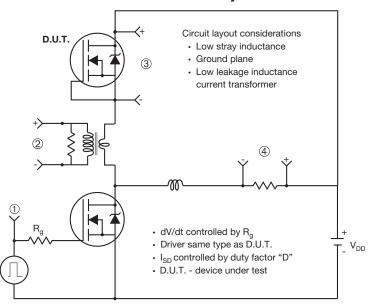


Fig. 13b - Gate Charge Test





### Peak Diode Recovery dV/dt Test Circuit



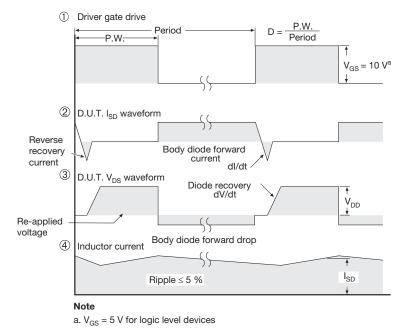


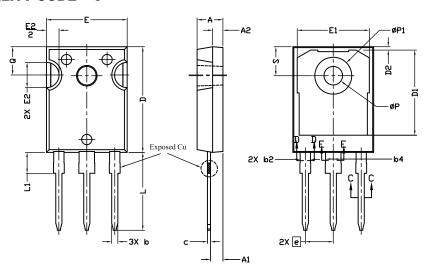
Fig. 14 - For N-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?91212.

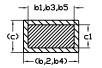


## **TO-247AC (High Voltage)**

### **VERSION 1: FACILITY CODE = 9**







Section C--C,D--D,E--E

	MILLIN	IETERS	
DIM.	MIN.	MAX.	NOTES
Α	4.83	5.21	
A1	2.29	2.55	
A2	1.50	2.49	
b	1.12	1.33	
b1	1.12	1.28	
b2	1.91	2.39	6
b3	1.91	2.34	
b4	2.87	3.22	6, 8
b5	2.87	3.18	
С	0.55	0.69	6
c1	0.55	0.65	
D	20.40	20.70	4

	MILLIN		
DIM.	MIN.	MAX.	NOTES
D1	16.25	16.85	5
D2	0.56	0.76	
E	15.50	15.87	4
E1	13.46	14.16	5
E2	4.52	5.49	3
е	5.44 BSC		
L	14.90	15.40	
L1	3.96	4.16	6
ØР	3.56	3.65	7
Ø P1	7.19		
Q	5.31	5.69	
S	5.54	5.74	

#### Notes

- (1) Package reference: JEDEC TO247, variation AC
- (2) All dimensions are in mm
- (3) Slot required, notch may be rounded
- (4) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm per side. These dimensions are measured at the outermost extremes of the plastic body
- (5) Thermal pad contour optional with dimensions D1 and E1
- (6) Lead finish uncontrolled in L1
- (7) Ø P to have a maximum draft angle of 1.5° to the top of the part with a maximum hole diameter of 3.91 mm
- (8) Dimension b2 and b4 does not include dambar protrusion. Allowable dambar protrusion shall be 0.1 mm total in excess of b2 and b4 dimension at maximum material condition

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### **VERSION 2: FACILITY CODE = Y**



	MILLIN	IETERS	
DIM.	MIN.	MAX.	NOTES
Α	4.58	5.31	
A1	2.21	2.59	
A2	1.17	2.49	
b	0.99	1.40	
b1	0.99	1.35	
b2	1.53	2.39	
b3	1.65	2.37	
b4	2.42	3.43	
b5	2.59	3.38	
С	0.38	0.86	
c1	0.38	0.76	
D	19.71	20.82	
D1	13.08	-	

	MILLIN		
DIM.	MIN.	MAX.	NOTES
D2	0.51	1.30	
E	15.29	15.87	
E1	13.72	-	
е	5.46	BSC	
Øk	0.2	254	
L	14.20	16.25	
L1	3.71	4.29	
ØΡ	3.51	3.66	
Ø P1	-	7.39	
Q	5.31	5.69	
R	4.52	5.49	
S	5.51	BSC	
	•		

ECN: E19-0614-Rev. E, 25-Nov-2019

DWG: 5971

### Notes

- (1) Dimensioning and tolerancing per ASME Y14.5M-1994
- (2) Contour of slot optional
- (3) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- (4) Thermal pad contour optional with dimensions D1 and E1
- (5) Lead finish uncontrolled in L1
- (6) Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")
- (7) Outline conforms to JEDEC outline TO-247 with exception of dimension c
- (8) Xian and Mingxin actually photo



Vishay

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